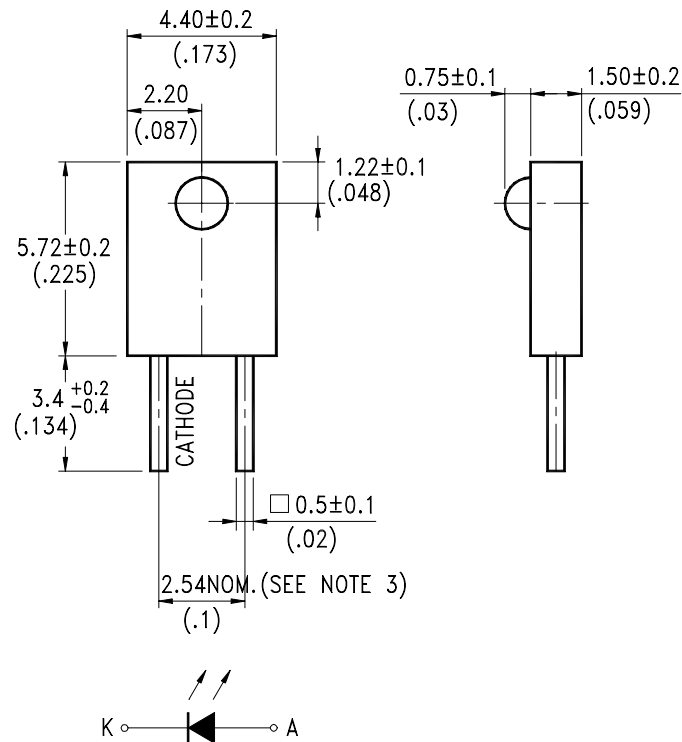


FEATURES

- * SELECTED TO SPECIFIC ON-LINE INTENSITY AND RADIANT INTENSITY RANGES
- * LOW COST MINIATURE PLASTIC SIDE LOOKING PACKAGE
- * MECHANICALLY AND SPECTRALLY MATCHED TO THE LTR-301 SERIES OF PHOTOTRANSISTOR

PACKAGE DIMENSIONS**NOTES:**

1. All dimensions are in millimeters (inches).
2. Tolerance is ± 0.25 mm(.010") unless otherwise noted.
3. Lead spacing is measured where the leads emerge from the package.
4. Specifications are subject to change without notice.

ABSOLUTE MAXIMUM RATINGS AT TA=25°C

PARAMETER	MAXIMUM RATING	UNIT
Power Dissipation	75	mW
Peak Forward Current (300pps, 10 μs pulse)	1	A
Continuous Forward Current	50	mA
Reverse Voltage	5	V
Operating Temperature Range	-40°C to +85°C	
Storage Temperature Range	-55°C to +100°C	
Lead Soldering Temperature [1.6mm(.063") From Body]	260°C for 5 Seconds	

ELECTRICAL / OPTICAL CHARACTERISTICS AT TA=25°C

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST COND.	BIN NO.
Peak Emission Wavelength	λ_p		940		nm	$I_F = 20mA$	
Spectral Line Half-Width	$\Delta \lambda$		50		nm	$I_F = 20mA$	
Forward Voltage	V_F		1.2	1.6	V	$I_F = 20mA$	
Reverse Current	I_R			100	μA	$V_R = 5V$	
Aperture Radiant Incidence	E_e	0.088		0.168	mW/cm ²	$I_F = 20mA$	BIN B
		0.112		0.204			BIN C
		0.136		0.240			BIN D
		0.160		0.288			BIN E
		0.192					BIN F
Radiant Intensity	I_E	0.662		1.263	mW/sr	$I_F = 20mA$	BIN B
		0.842		1.534			BIN C
		1.023		1.805			BIN D
		1.203		2.165			BIN E
		1.444					BIN F
Viewing Angle (See FIG.6)	$2\theta_{1/2}$		40		deg.		

TYPICAL ELECTRICAL / OPTICAL CHARACTERISTICS CURVES

(25°C Ambient Temperature Unless Otherwise Noted)

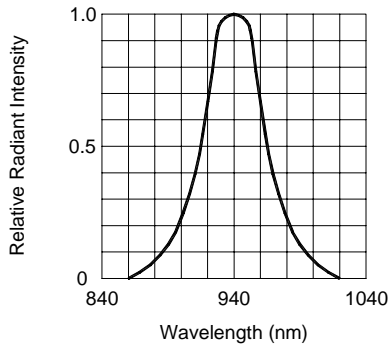


FIG.1 SPECTRAL DISTRIBUTION

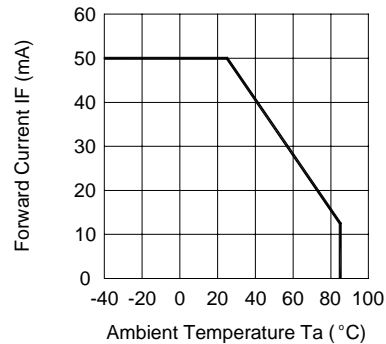


FIG.2 FORWARD CURRENT VS. AMBIENT TEMPERATURE

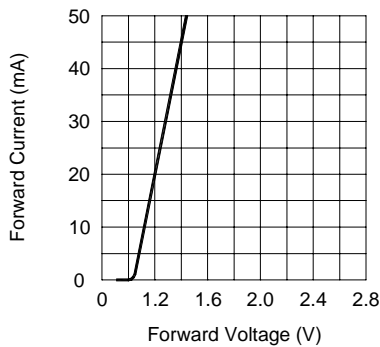


FIG.3 FORWARD CURRENT VS. FORWARD VOLTAGE

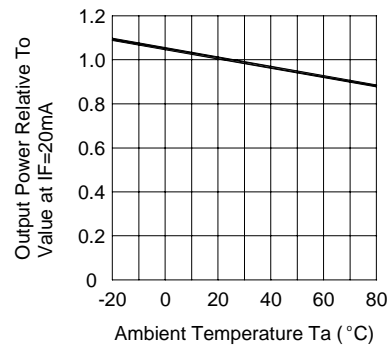


FIG.4 RELATIVE RADIANT INTENSITY VS. AMBIENT TEMPERATURE

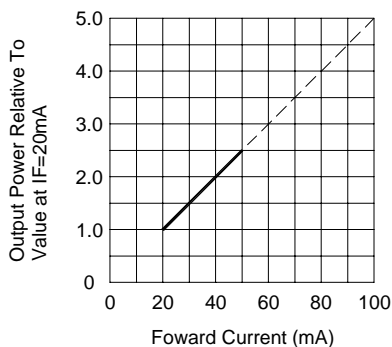


FIG.5 RELATIVE RADIANT INTENSITY VS. FORWARD CURRENT

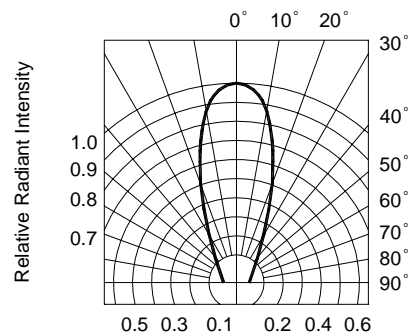


FIG.6 RADIATION DIAGRAM